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We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



### Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









### 2.0x1.25mm PHOTOTRANSISTOR

Part Number: APT2012P3BT

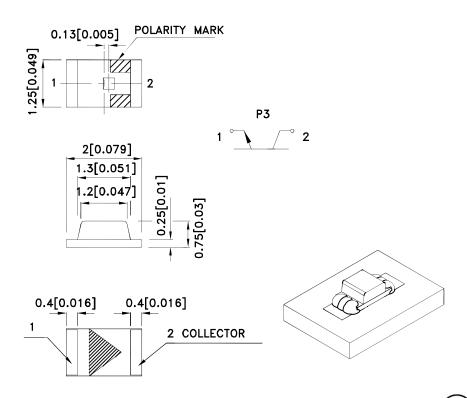
#### **Features**

- 2.0mmx1.25mm SMT LED,0.75mm thickness.
- Mechanically and spectrally matched to infrared emitting LED lamp.
- Package: 2000pcs / reel .
- Blue transparent lens.
- Moisture sensitivity level : level 3.
- RoHS compliant.

### Description

Made with NPN silicon phototransistor chips.

### **Package Dimensions**



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.1(0.004")$  unless otherwise noted.
- The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
   The device has a single mounting surface. The device must be mounted according to the specifications.

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### Electrical / Optical Characteristics at TA=25°C

| Symbol    | Parameter                               | Min. | Тур. | Max. | Units | Test Conditions  |
|-----------|---|------|------|------|-------|--|
| VBR CEO   | Collector-to-Emitter Breakdown Voltage  | 30   |      |      | V     | Ic=100uA<br>Ee=0mW/c m²  |
| VBR ECO   | Emitter-to-Collector Breakdown Voltage  | 5    |      |      | V     | IE=100uA<br>Ee=0mW/c m <sup>2</sup>                                  |
| VCE (SAT) | Collector-to-Emitter Saturation Voltage |      |      | 0.8  | V     | Ic=2mA<br>Ee=20mW/c m²   |
| I CEO     | Collector Dark Current                  |      |      | 100  | nA    | Vc=10V<br>Ee=0mW/c m²  |
| TR        | Rise Time (10% to 90%)                  |      | 15   |      | us    | V <sub>CE</sub> = 5V<br>I <sub>C</sub> =1mA<br>R <sub>L</sub> =1000Ω |
| TF        | Fall Time (90% to 10%)                  |      | 15   |      | us    |  |
| I (ON)    | On State Collector Current              | 0.1  | 0.3  |      | mA    | VcE = 5V<br>Ee=1mW/c m <sup>2</sup><br>λ=940nm                       |
| 2θ1/2     | Angle of half sensitivity               |      | 120  |      | deg   |  |

### Absolute Maximum Ratings at TA=25°C

| Parameter   | Max.Ratings    |  |  |  |
|---|----------------|--|--|--|
| Collector-to-Emitter Voltage                              | 30V            |  |  |  |
| Emitter-to-Collector Voltage                              | 5V             |  |  |  |
| Power Dissipation at (or below) 25°C Free Air Temperature | 100mW          |  |  |  |
| Operating Temperature                                     | -40°C To +85°C |  |  |  |
| Storage Temperature                                       | -40°C To +85°C |  |  |  |

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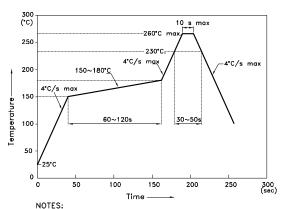
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### APT2012P3BT

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



- NOTES:

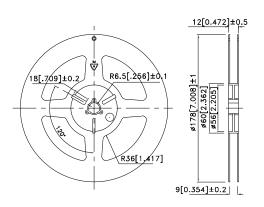
  1.We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C. 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
   3.Number of reflow process shall be 2 times or less.

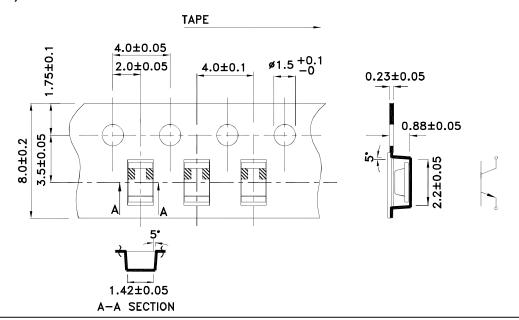
### **Recommended Soldering Pattern** (Units: mm; Tolerance: ± 0.1)

# 1.25 1.25

### **Tape Specifications** (Units: mm)

### **Reel Dimension**

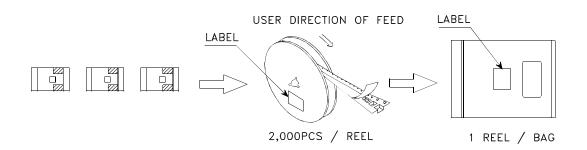


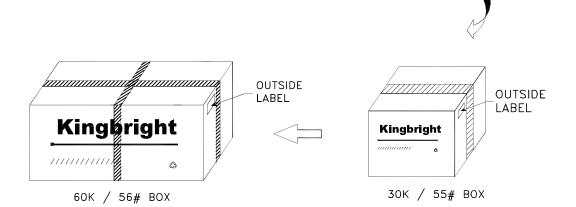


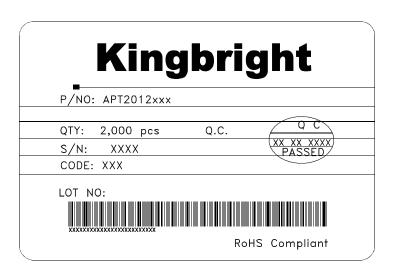
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#### **PACKING & LABEL SPECIFICATIONS** APT2012P3BT







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